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PATENT



IN THE UNITED STATES PATENT
AND TRADEMARK OFFICE

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|----------------------|-------------------------|---|------------------------------------------------|
| Applicant: | Dong Joon Kim |) | I hereby certify that this paper is being |
| Serial No.: | 10/636,168 |) | deposited with the United States Postal |
| Filed: | August 7, 2003 |) | Service with sufficient postage as first |
| Title: | METHOD OF FORMING METAL |) | class mail in an envelope addressed to |
| | LINE IN SEMICONDUCTOR |) | Mail Stop Amendment, Commissioner for |
| | DEVICE |) | Patents, P.O. Box 1450, Alexandria, |
| | |) | Virginia 22313-1450, on July 27, 2004 . |
| Group Art Unit: | 2818 |) | |
| Examiner: | David Nhu |) | |
| Attorney Docket No.: | 29936/39478 |) | |


Sandip H. Patel (Reg. No. 43,848)
Attorney for Applicant

AMENDMENT "A" AND
RESPONSE TO OFFICIAL ACTION

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Dear Sir:

In response to the non-final official action dated April 29, 2004, please amend the above-identified patent application as set forth herein.

Amendments to the claims begin on page 2 of this paper.

Remarks begin on page 5 of this paper.